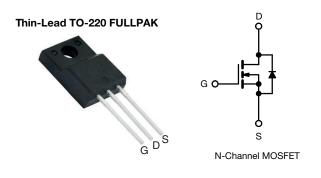
SiHA12N50E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	550				
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V 0.380				
Q _g max. (nC)	50				
Q _{gs} (nC)	6				
Q _{gd} (nC)	10				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting
- Consumer electronics
- Applications using hard switched topologies
 - Power factor correction (PFC)
 - Two switch forward converter
 - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free	SiHA12N50E-E3			
Lead (Pb)-free and halogen-free	SiHA12N50E-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	500	N	
Gate-source voltage			V _{GS}	± 30	- V	
Continuous drain surrant (T 150 °C) f	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$		10.5		
Continuous drain current ($T_J = 150 \ ^\circ C$) e	V _{GS} at 10 V	T _C = 100 °C	I _D	6.6	A	
Pulsed drain current ^a			I _{DM}	21	1	
Linear derating factor				0.91	W/°C	
Single pulse avalanche energy ^b			E _{AS}	103	mJ	
Maximum power dissipation			P _D	32	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	$V_{DS} = 0 V t$	to 80 % V _{DS}	d\//dt	70		
Reverse diode dV/dt ^d			dV/dt	27	V/ns	
Soldering recommendations (peak temperature) ^c	for 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,\,I_{AS}$ = 2.7 A
- c. 1.6 mm from case
- d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C
- e. Limited by maximum junction temperature

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-	- 65					
Maximum junction-to-case (drain)	R _{thJC}	- 3.9			°C/W			
	•	•						
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, ι	inless otherwi	se noted)						
PARAMETER	SYMBOL			ONS	MIN.	TYP.	MAX.	UNI
Static				-				<u> </u>
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA		50 µA	500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C, Ir		-	0.60	-	V/°(
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	- 50 μΑ	2.0	-	4.0	V
	00(0)		$V_{GS} = \pm 20$ V		-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30$ V		-	-	± 1	μA
			= 500 V, V _{GS}		-	-	1	<u> </u>
Zero gate voltage drain current	I _{DSS}		$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V		= 6 A	-	0.330	0.380	Ω
Forward transconductance	g _{fs}	V _{DS}	= 30 V, I _D =	6 A	-	3.1	-	S
Dynamic						ļ	ļ	
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	886	-		
Output capacitance	C _{oss}			-	52	-		
Reverse transfer capacitance	C _{rss}			-	6	-		
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		-	45	-	pF	
Effective output capacitance, time related ^b	C _{o(tr)}			-	131	-	1	
Total gate charge	Qg			-	25	50		
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	$V_{GS} = 10 V$ $I_D = 6 A, V_{DS} = 400 V$		-	6	-	nC
Gate-drain charge	Q _{gd}				-	10	-	1
Turn-on delay time	t _{d(on)}				-	13	26	
Rise time	t _r	$V_{DD} = 400 \text{ V}, \text{ I}_D = 6 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_g = 9.1 \Omega$ f = 1 MHz, open drain		-	16	32		
Turn-off delay time	t _{d(off)}			-	29	58	- ns	
Fall time	t _f			-	12	24		
Gate input resistance	Rg			-	0.92	-	Ω	
Drain-Source Body Diode Characteristic	cs							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10.5	A	
Pulsed diode forward current	I _{SM}			-	-	21		
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 7.5 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 6 \text{ A},$ dl/dt = 100 A/µs, V _R = 25 V		-	244	-	ns	
Reverse recovery charge	Q _{rr}			-	2.5	-	μ	
Reverse recovery current	I _{RRM}			-	19	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

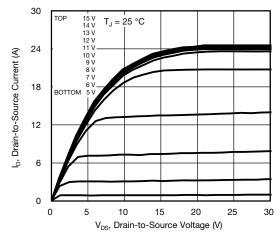
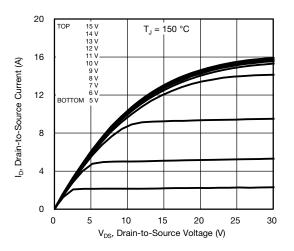


Fig. 1 - Typical Output Characteristics





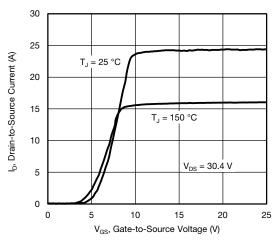


Fig. 3 - Typical Transfer Characteristics

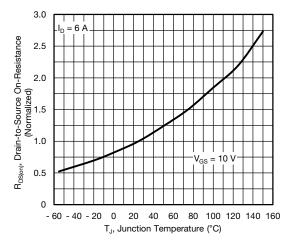


Fig. 4 - Normalized On-Resistance vs. Temperature

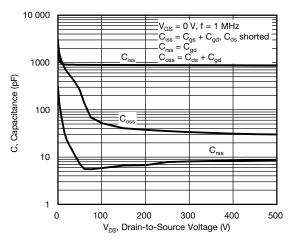


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

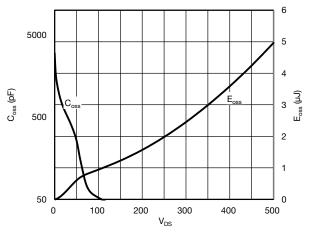


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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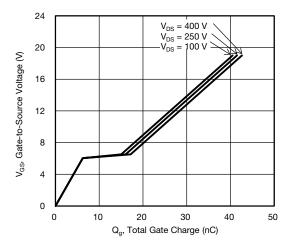


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

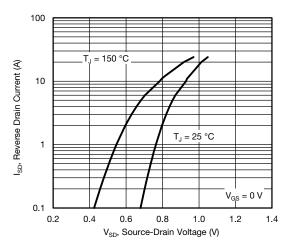


Fig. 8 - Typical Source-Drain Diode Forward Voltage

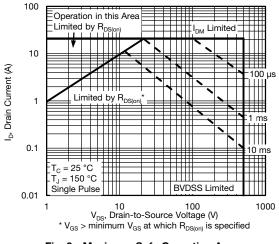


Fig. 9 - Maximum Safe Operating Area

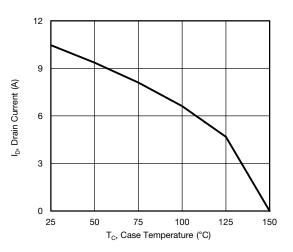


Fig. 10 - Maximum Drain Current vs. Case Temperature

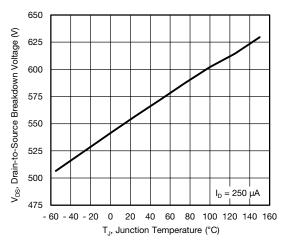
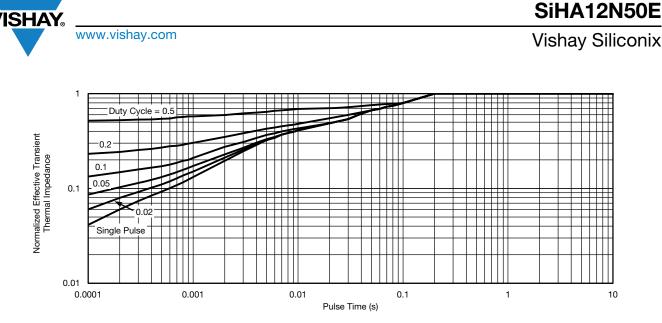


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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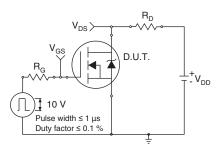


Fig. 13 - Switching Time Test Circuit

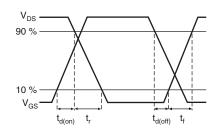


Fig. 14 - Switching Time Waveforms

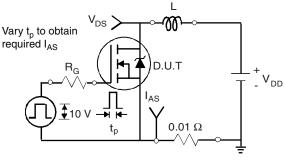


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

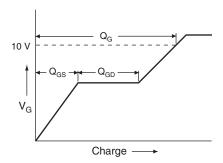


Fig. 17 - Basic Gate Charge Waveform

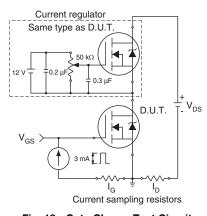


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

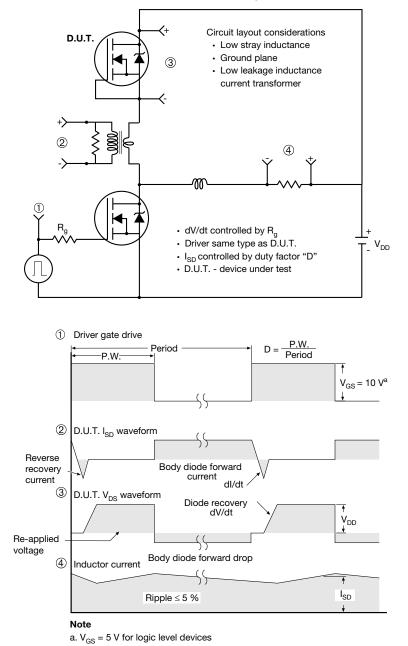


Fig. 19 - For N-Channel

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Vishay Siliconix

TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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